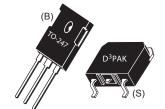






## Super Junction MOSFET



- Ultra Low R<sub>DS(ON)</sub>
- Low Miller Capacitance
- Ultra Low Gate Charge, Qq
- Avalanche Energy Rated
- Extreme dv/<sub>dt</sub> Rated
- Popular TO-247 or Surface Mount D<sup>3</sup> Package



# **MAXIMUM RATINGS** All Ratings: $T_C = 25^{\circ}C$ unless otherwise specified.

Symbol	Parameter	APT60N60BCSG_SCSG	UNIT
V <sub>DSS</sub>	Drain-Source Voltage	600	Volts
I <sub>D</sub>	Continuous Drain Current @ T <sub>C</sub> = 25°C	60	
.D	Continuous Drain Current @ T <sub>C</sub> = 100°C	38	Amps
I <sub>DM</sub>	Pulsed Drain Current <sup>①</sup>	230	
V <sub>GS</sub>	Gate-Source Voltage Continuous	±30	Volts
P <sub>D</sub>	Total Power Dissipation @ T <sub>C</sub> = 25°C	431	Watts
, p	Linear Derating Factor	3.45	W/°C
T <sub>J</sub> ,T <sub>STG</sub>	Operating and Storage Junction Temperature Range	-55 to 150	°C
$T_L$	Lead Temperature: 0.063" from Case for 10 Sec.	260	C
dv/ <sub>dt</sub>	MOSFET dv/dt Ruggedness (V <sub>DS</sub> = 480V)	50	V/ns
I <sub>AR</sub>	Avalanche Current <sup>②</sup>	11	Amps
E <sub>AR</sub>	Repetitive Avalanche Energy <sup>②</sup>	3	mJ
E <sub>AS</sub>	Single Pulse Avalanche Energy <sup>③</sup>	1950	1110

#### STATIC ELECTRICAL CHARACTERISTICS

Symbol	Characteristic / Test Conditions	MIN	TYP	MAX	UNIT
V <sub>(BR)DSS</sub>	Drain-Source Breakdown Voltage ( $V_{GS} = 0V$ , $I_D = 250\mu A$ )	600			Volts
R <sub>DS(on)</sub>	Drain-Source On-State Resistance $^{\textcircled{4}}$ ( $V_{GS} = 10V$ , $I_{D} = 44A$ )			0.045	Ohms
I <sub>DSS</sub>	Zero Gate Voltage Drain Current $(V_{DS} = 600V, V_{GS} = 0V)$			25	- μΑ
	Zero Gate Voltage Drain Current ( $V_{DS} = 600V, V_{GS} = 0V, T_{C} = 150^{\circ}C$ )			250	
I <sub>GSS</sub>	Gate-Source Leakage Current (V <sub>GS</sub> = ±20V, V <sub>DS</sub> = 0V)			±100	nA
V <sub>GS(th)</sub>	Gate Threshold Voltage $(V_{DS} = V_{GS}, I_{D} = 3mA)$	2.1	3	3.9	Volts

CAUTION: These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

"COOLMOS™ comprise a new family of transistors developed by Infineon Technologies AG. "COOLMOS" is a trademark of Infineon Technologies AG."

#### **DYNAMIC CHARACTERISTICS**

#### APT60N60BCSG\_SCSG

Symbol	Characteristic	Test Conditions	MIN	TYP	MAX	UNIT
C <sub>iss</sub>	Input Capacitance	V <sub>GS</sub> = 0V		7200		
C <sub>oss</sub>	Output Capacitance	V <sub>DS</sub> = 25V		8500		pF
C <sub>rss</sub>	Reverse Transfer Capacitance	f = 1 MHz		290		
$Q_g$	Total Gate Charge <sup>⑤</sup>	V <sub>GS</sub> = 10V		150	190	
Q <sub>gs</sub>	Gate-Source Charge	V <sub>DD</sub> = 400V		34		nC
Q <sub>gd</sub>	Gate-Drain ("Miller") Charge	I <sub>D</sub> = 44A @ 25°C		50		
t <sub>d(on)</sub>	Turn-on Delay Time	RESISTIVE SWITCHING		30		
t <sub>r</sub>	Rise Time	$V_{GS} = 15V$ $V_{DD} = 400V$		20		ns
t <sub>d(off)</sub>	Turn-off Delay Time	I <sub>D</sub> = 44A @ 25°C		100		
t <sub>f</sub>	Fall Time	$R_{G} = 4.3\Omega$		10		
E <sub>on</sub>	Turn-on Switching Energy <sup>⑥</sup>	INDUCTIVE SWITCHING @ 25°C  V <sub>DD</sub> = 400V, V <sub>GS</sub> = 15V		675		
E <sub>off</sub>	Turn-off Switching Energy	$I_{D} = 44A, R_{G} = 4.3\Omega$		520		μJ
E <sub>on</sub>	Turn-on Switching Energy <sup>6</sup>	INDUCTIVE SWITCHING @ 125°C  V <sub>DD</sub> = 400V, V <sub>GS</sub> = 15V		1100		μo
E <sub>off</sub>	Turn-off Switching Energy	$I_{D} = 44A, R_{G} = 4.3\Omega$		635		

#### SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS

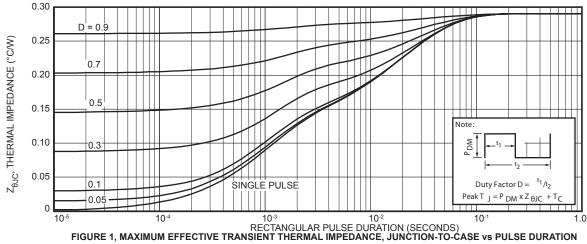
Symbol	Characteristic / Test Conditions	MIN	TYP	MAX	UNIT
Is	Continuous Source Current (Body Diode)			44	Amno
I <sub>SM</sub>	Pulsed Source Current (1) (Body Diode)			180	Amps
V <sub>SD</sub>	Diode Forward Voltage $^{\textcircled{4}}$ (V <sub>GS</sub> = 0V, I <sub>S</sub> = -44A)			1.2	Volts
t <sub>rr</sub>	Reverse Recovery Time $(I_S = -44A, dI_S/dt = 100A/\mu s)$		600		ns
Q <sub>rr</sub>	Reverse Recovery Charge $(I_S = -44A, dI_S/dt = 100A/\mu s)$		17		μC
dv <sub>/</sub> dt	Peak Diode Recovery <sup>dv</sup> / <sub>dt</sub> ⑦			4	V/ns

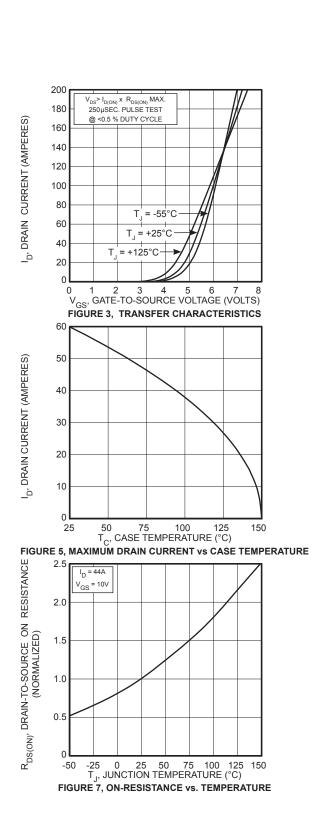
#### THERMAL CHARACTERISTICS

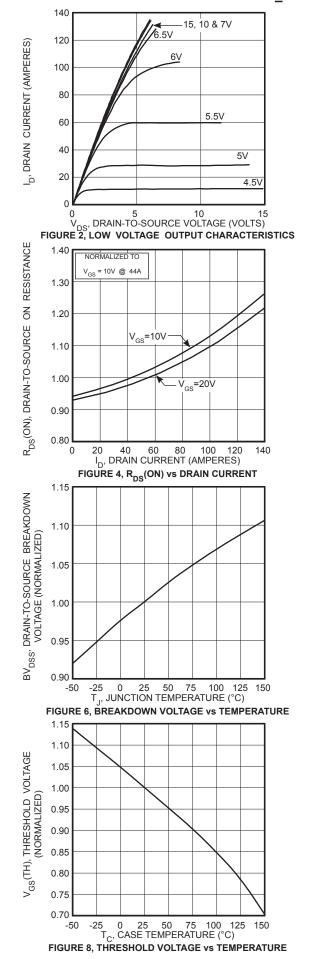
Symbol	Characteristic	MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to Case			0.29	0000
R <sub>AJA</sub>	Junction to Ambient			40	°C/W

- (1) Repetitive Rating: Pulse width limited by maximum junction temperature
- ② Repetitive avalanche causes additional power losses that can be calculated as  $P_{AV}$  =  $E_{AR}$ \*f ③ Starting  $T_j$  = +25°C, L = 33.23mH,  $R_G$  = 25 $\Omega$ , Peak  $I_L$  = 11A
- 4 Pulse Test: Pulse width < 380µs, Duty Cycle < 2%
- ⑤ See MIL-STD-750 Method 3471
- 6 Eon includes diode reverse recovery. See figures 18, 20.
- ⑦ We do not recommend using this CoolMOS™ product in topologies that have fee wheeling load current conducted in the body diode that is hard commutated. The current commutation is very "snappy", resulting in high di/dt at the completion of commutation, and the likelihood of severe over-voltage transients due to the resulting high dv/dt.

Microsemi Reserves the right to change, without notice, the specifications and information contained herein.







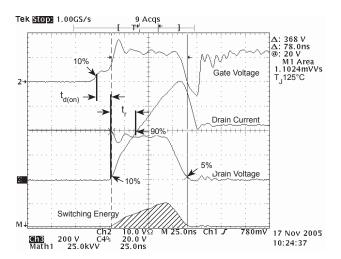


Figure 17, Turn-on Switching Waveforms and Definitions

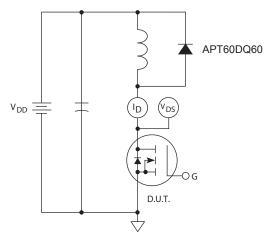


Figure 19, Inductive Switching Test Circuit

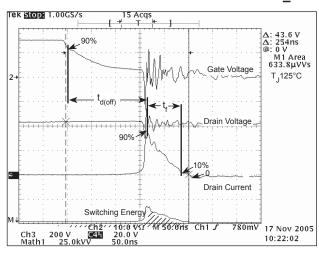
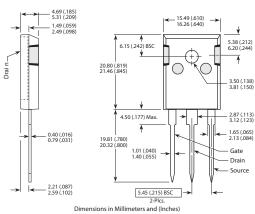


Figure 18, Turn-off Switching Waveforms and Definitions

### **TO-247 Package Outline**





#### D³PAK Package Outline

@3100% Sn

